

Refine Search

Search Results -

Terms	Documents
L2 and (stop? near2 polymer)	1

Database:

US Pre-Grant Publication Full-Text Database
 US Patents Full-Text Database
 US OCR Full-Text Database
 EPO Abstracts Database
 JPO Abstracts Database
 Derwent World Patents Index
 IBM Technical Disclosure Bulletins

Search:

L3

Search History

DATE: Monday, March 22, 2004 [Printable Copy](#) [Create Case](#)

Set Name Query

side by side

DB=USPT; PLUR=YES; OP=ADJ

Hit Count Set Name

result set

<u>L3</u>	L2 and (stop? near2 polymer)	1	<u>L3</u>
<u>L2</u>	L1 and cmp	1269	<u>L2</u>
<u>L1</u>	(polishing or polish) near2 (stop or stopper)	1869	<u>L1</u>

END OF SEARCH HISTORY

Hit List

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Generate OACS				

Search Results - Record(s) 1 through 2 of 2 returned.

☐ 1. Document ID: US 6417116 B2

L4: Entry 1 of 2

File: USPT

Jul 9, 2002

US-PAT-NO: 6417116

DOCUMENT-IDENTIFIER: US 6417116 B2

TITLE: Semiconductor device having a multilayer interconnection structure

Full	Title	Citation	Front	Review	Classification	Date	Reference			Claims	RMC	Draw Dc
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☐ 2. Document ID: US 6383933 B1

L4: Entry 2 of 2

File: USPT

May 7, 2002

US-PAT-NO: 6383933

DOCUMENT-IDENTIFIER: US 6383933 B1

TITLE: Method of using organic material to enhance STI planarization or other planarization processes

Full	Title	Citation	Front	Review	Classification	Date	Reference			Claims	RMC	Draw Dc
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Terms	Documents
L2 and ((organic or polymer) near2 (stop?))	2

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Search Results - Record(s) 1 through 1 of 1 returned.

☐ 1. Document ID: US 6383933 B1

L3: Entry 1 of 1

File: USPT

May 7, 2002

US-PAT-NO: 6383933

DOCUMENT-IDENTIFIER: US 6383933 B1

TITLE: Method of using organic material to enhance STI planarization or other planarization processes

Full	Title	Citation	Front	Review	Classification	Date	Reference			Claims	KMC	Draw D
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Terms	Documents
L2 and (stop? near2 polymer)	1

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